

FDP10N50F / FDPF10N50FT N-Channel MOSFET 500V, 9A, 0.85Ω

Features

- R_{DS(on)} = 0.71Ω (Typ.) @ V_{GS} = 10V, I_D = 4.5A
- Low Gate Charge (Typ. 18nC)
- Low C_{rss} (Typ. 10pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability

GDS

RoHS Compliant

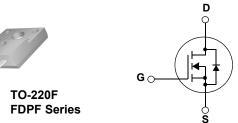


GDS

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.





TO-220

FDP Series

Symbol	Parameter			FDP10N50F	FDPF10N50FT	Units	
V _{DSS}	Drain to Source Voltage			500		V	
V _{GSS}	Gate to Source Voltage			±30		V	
ID	Drain Current	-Continuous (T _C = 25 ^o C)		9	9*		
		-Continuous (T _C = 100 ^o C)		5.4	5.4*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	36	36*	А	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	364		mJ	
I _{AR}	Avalanche Current		(Note 1)	9		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	1	12.5		
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns	
P _D	Power Dissipation	$(T_{C} = 25^{\circ}C)$		125	42	W	
		- Derate above 25°C		1.0	0.33	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds300			00	°C		
	mited by maximum junction tempera	ature	I				
Symphol		Deveneter				Unite	

Symbol	Parameter	FDP10N50F	FDPF10N50FT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.0	3.0	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	62.5	0/11

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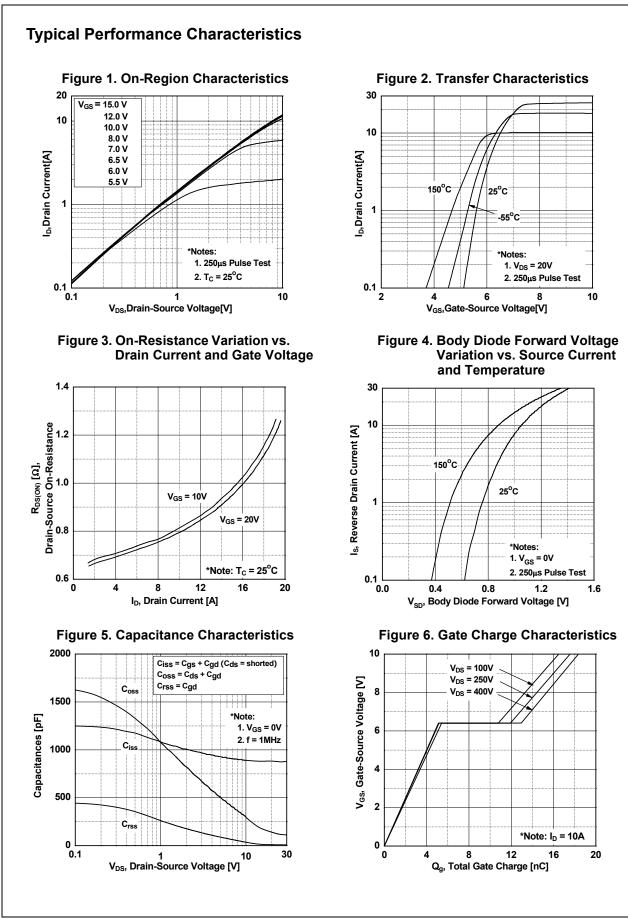
UniFET™

Device Marking		Device	Packa	ge	Reel Size	Таре	e Width		Quantit	у
<u> </u>		FDP10N50F	TO-22	20	-		-	50		-
		TO-22	0F	-		-		50		
Electrica	l Char	acteristics								
Symbol				Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	teristic	S		1		¥				
BV _{DSS}	Drain to	o Source Breakdown V	oltage	I _D = 2	$I_D = 250 \mu A, V_{GS} = 0V, T_J = 25^{\circ}C$		500	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakd Coeffic	own Voltage Temperat ient	ure		$I_D = 250 \mu$ A, Referenced to 25° C		-	0.5	-	V/ºC
	Zoro C	ata Valtaga Drain Curr	ont		500V, V _{GS} = 0V		-	-	10	
IDSS	Zero G	Zero Gate Voltage Drain Current		V _{DS} =	$V_{DS} = 400V, T_{C} = 125^{\circ}C$		-	-	100	μA
I _{GSS}	Gate to	Body Leakage Currer	nt	V _{GS} =	±30V, V _{DS} = 0V		-	-	±100	nA
On Charac	teristic	:S								
V _{GS(th)}	Gate T	hreshold Voltage		V _{GS} =	V _{GS} = V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}					10V, I _D = 4.5A		-	0.71	0.85	Ω
9FS	Forwar				20V, I _D = 4.5A	(Note 4)	-	8.5	-	S
Dynamic C	haract	eristics								
C _{iss}	Input C	apacitance			-	880	1170	pF		
C _{oss}	Output	Capacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	120	160	pF	
C _{rss}	Revers	e Transfer Capacitance	Э	1 - 110	11 12		-	10	15	pF
Qg	Total G	ate Charge at 10V					-	18	24	nC
Q _{gs}	Gate to	Source Gate Charge		-	$V_{DS} = 400V, I_D = 10A$		-	5	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge		V _{GS} = 10V		(Note 4, 5)	-	7.5	-	nC
Switching	Charac	teristics								
t _{d(on)}	Turn-O	n Delay Time					-	20	50	ns
t _r	Turn-O	n Rise Time			V _{DD} = 250V, I _D = 10A		-	40	90	ns
t _{d(off)}	Turn-O	ff Delay Time		$R_{G} = 25\Omega$		-	45	100	ns	
t _f	Turn-O	ff Fall Time	(Note 4, 5)		-	30	70	ns		
Drain-Sou	ce Dio	de Characteristic	S							
I _S	Maximum Continuous Drain to Source Diode			de Forwa	e Forward Current		-	-	9	Α
I _{SM}	Maximu	kimum Pulsed Drain to Source Diode For		orward C			-	-	60	Α
V _{SD}	Drain to	Source Diode Forwar	d Voltage	V _{GS} =	0V, I _{SD} = 9A		-	-	1.5	V
t _{rr}	Reverse	e Recovery Time			0V, I _{SD} = 9A		-	95	-	ns
Q _{rr}	Reverse	e Recovery Charge		00	= 100A/µs	(Note 4)	-	0.2	-	μC

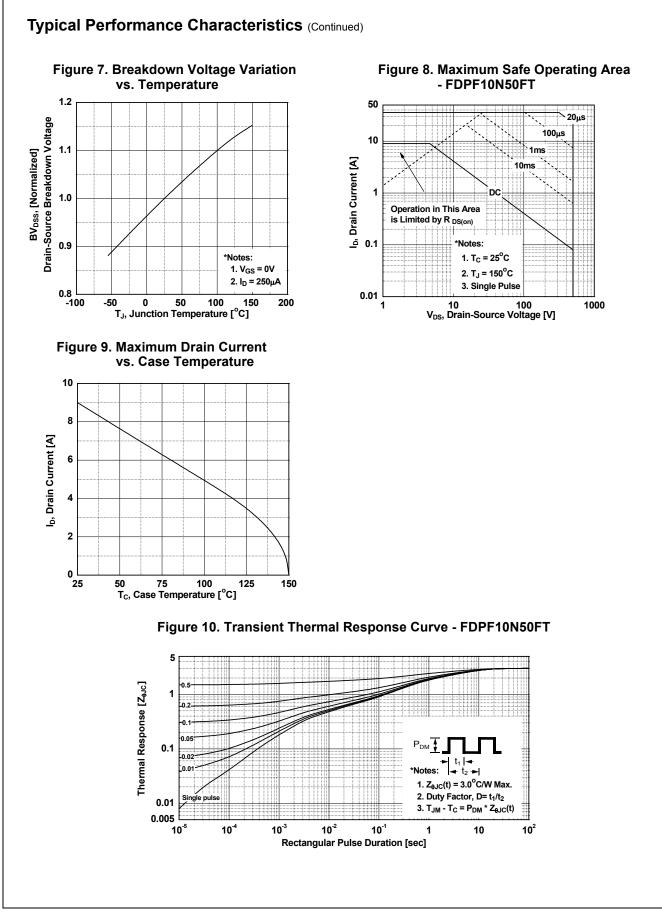
1: Repetitive Rating: Puise width limited by maximum junction temperature 2: L = 9mH, I_{AS} = 9A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C 3: I_{SD} = 8A, di/dt $\geq 200A'\mu$ s, V_{DD} $\leq BV_{DSS}$, Starting T_J = 25°C 4: Pulse Test: Pulse width $\leq 300\mu$ s, Duty Cycle $\leq 2\%$ 5: Essentially Independent of Operating Temperature Typical Characteristics

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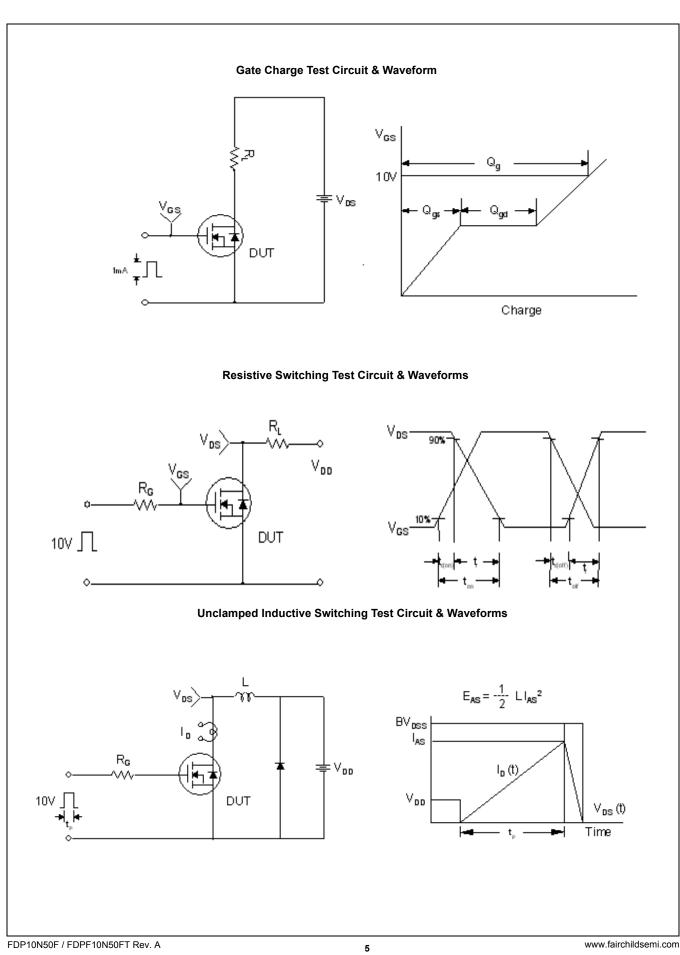


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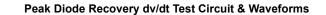


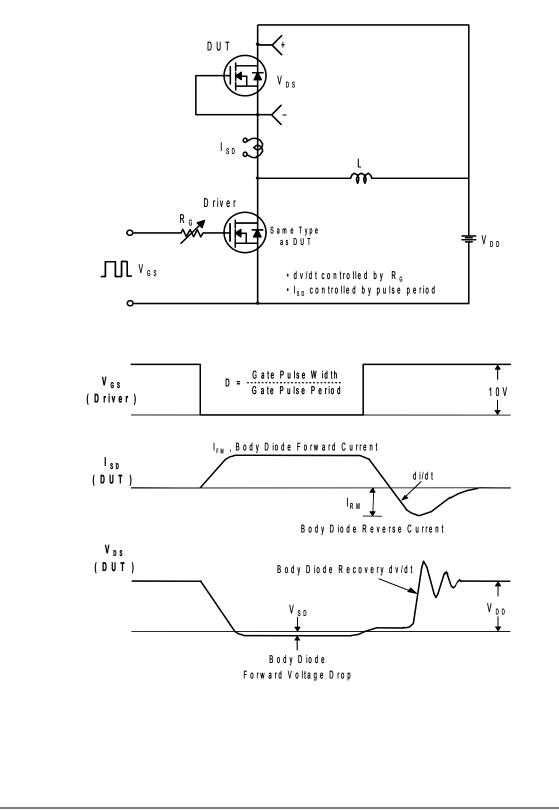
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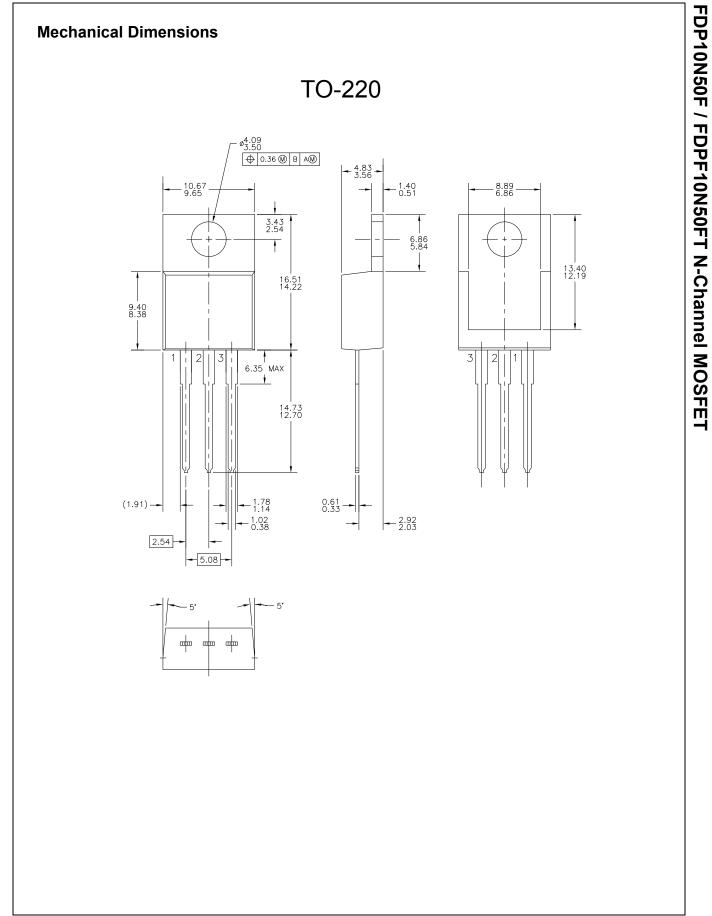


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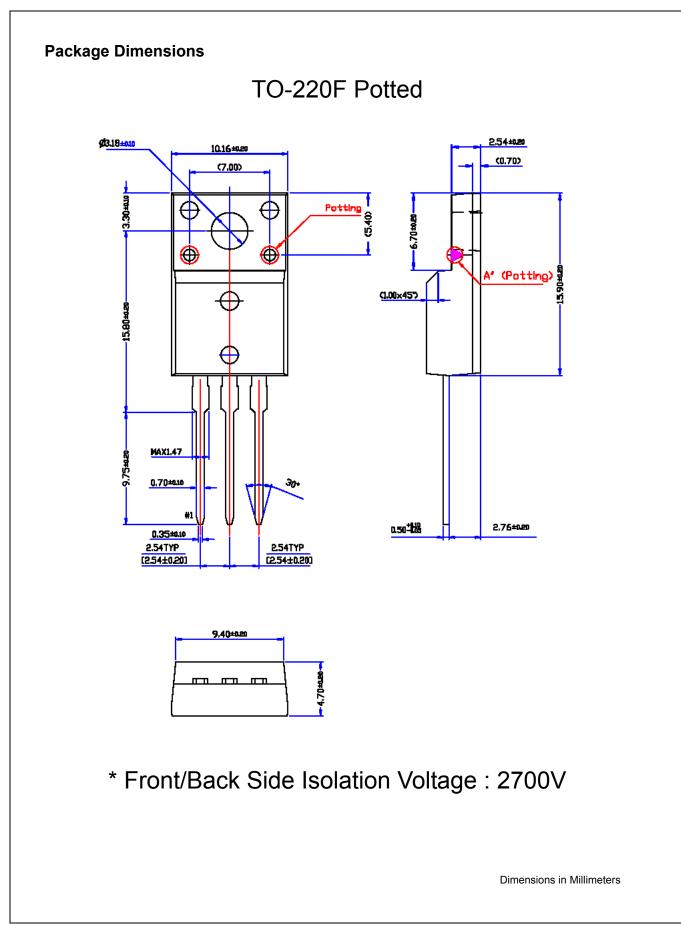




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